



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Takashi TAKAMURA

Serial No: 10/622,038

Confirmation No.: 2258

Filed: July 17, 2003

For: METHOD FOR PREVENTING ELECTROSTATIC
DAMAGE TO A SEMICONDUCTOR CHIP PACKAGE
DURING STORAGE (as amended)

Art Unit: 2814

Examiner: Dilinh P. Nguyen

I hereby certify that this correspondence is
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Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450, on
October 26, 2004

Date of Deposit

Joyce Hegeman

Name

Signature

October 26, 2004
Date

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Transmitted in the above-identified application are the following items.

- ☒ Amendment
☒ Return postcard

The fee has been calculated as shown below:

	(Col. 1) CLAIMS REMAINING AFTER AMENDMENT		(Col. 2) HIGHEST NUMBER PREVIOUSLY PAID FOR	(Col. 3) PRESENT EXTRA*	LG/SM \$ ENTITY FEE	ADD'L FEE DUE
TOTAL CLAIMS FEE	9	-20	20 **	0	LG=\$18 SM=\$9	\$18 \$ 0
INDEPENDENT CLAIMS FEE	1	-3	1 ***	0	LG=\$86 SM=\$43	\$86 \$ 0
FIRST PRESENTATION OF MULTIPLE DEPENDENT CLAIMS					LARGE ENTITY FEE = \$290 SMALL ENTITY FEE = \$145	\$ 0
TOTAL						\$ 0

* If the entry in Col. 1 is less than the entry in Col. 2, write "0" in Col. 3.

** If the "Highest Number Previously Paid For" IN THIS SPACE is less than 20, write "20" in this space.

*** If the "Highest Number Previously Paid For" IN THIS SPACE is less than 3, write "3" in this space. The "Highest Number Previously Paid For" (Total or Independent) is the highest number found from the equivalent box on Col. 1 of a prior amendment or the number of claims originally filed.

- ☐ A check in the amount of \$ -0- to cover the additional claims fee is enclosed. **A copy of this sheet is enclosed.**
- ☐ A check in the amount of \$ -0- to cover the extension fee is enclosed. **A copy of this sheet is enclosed.**
- ☒ The Commissioner is hereby authorized to charge any deficiencies of fees associated with this communication or credit any overpayment to Deposit Account No. 50-1314. **A copy of this sheet is enclosed.**
- ☒ Any filing fees under 37 C.F.R. § 1.16 for the presentation of extra claims
- ☒ Any patent application processing fees under 37 C.F.R. § 1.17

Respectfully submitted,
HOGAN & HARTSON L.L.P.

By:

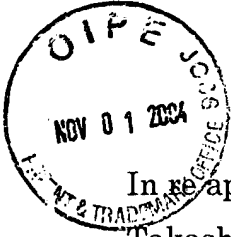
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Date: October 26, 2004

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Appl. No. 10/622,038
Amdt. Dated October 26, 2004
Reply to Office Action of July 26, 2004

Attorney Docket No. 81754.0096
Customer No.: 26021



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10/26/04

Date

AMENDMENT

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

In response to the Office Action dated July 26, 2004, please amend this
application as follows:

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims, which begins on
page 3 of this paper.

Remarks/Arguments begin on page 5 of this paper.